PCN Number:			20130719001						PCN Date:		07/24/2013	
Title: TL4242-Q1 d		atasheet - CMS C1306189										
<b>Customer Contact:</b>			PCN Manager			Phone:	+1(214) 480-	6037	Dept:	Quality Services		
<b>Change Type:</b>												
Assembly Site					Assembly Process				Assembly Materials			
Design					Electrical Specification				Mechanical Specification			
Test Site					Packing/Shipping/Labeling				Test Process			
Wafer Bump Site					Wafer Bump Material				Wafer Bump Process			
Wafer Fab Site					Wafer Fab Materials				Wafer Fab Process			
PCN Details												

### **Description of Change:**

Texas Instruments publication SLVS732 has changed as described below. Figure 6 has been added to page 7.

## TYPICAL CHARACTERISTICS (continued)

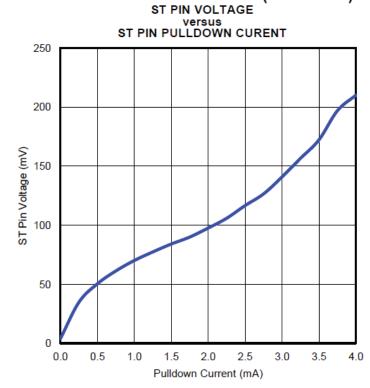


Figure 6.

# Reason for Change: Customer request

### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual devices.

### **Changes to product identification resulting from this PCN:**

None

### **Product Affected:**

TL4242QKTTRQ1 TL4242TDRJRQ1

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com